

1 Characteristics

Table 1. Absolute ratings

| Symbol | Parameter | | Value | Unit |
|-----------|---|---------------------------------|-------------|------|
| V_{PP} | Peak pulse voltage | IEC 61000-4-2 air discharge | 30 | kV |
| | | IEC 61000-4-2 contact discharge | 15 | |
| | | MIL STD883G-Method 3015-7 | 25 | |
| T_{stg} | Storage temperature range | | -55 to +150 | °C |
| T_j | Operating junction temperature range | | -40 to +125 | °C |
| T_L | Lead solder temperature (10 seconds duration) | | 260 | °C |

Table 2. Electrical characteristics ($T_{amb} = 25\text{ °C}$)

| Symbol | Parameter | Test conditions | Value | | | Unit |
|----------------------|---|--|-------|-------|------|------|
| | | | Min. | Typ. | Max. | |
| V_{BR} | $I_R = 1\text{ mA}$ | | 6 | | | V |
| I_{RM} | $V_{RM} = 3\text{ V}, V_{CC}\text{ to GND}$ | | | | 10 | nA |
| | $V_{RM} = 1\text{ V}, V_{CC}\text{ to GND}$ | | | | 1 | |
| V_F | Forward voltage | $I_F = 10\text{ mA}$ | | | 1.1 | V |
| V_{CL} | Clamping voltage | $I_{PP} = 1\text{ A}, 8/20\text{ }\mu\text{s}$ Any I/O pin to GND | | | 12 | V |
| | | $I_{PP} = 5\text{ A}, 8/20\text{ }\mu\text{s}$ Any I/O pin to GND | | | 17 | V |
| $C_{i/o-GND}$ | Capacitance between I/O and GND | $V_R = 1.65\text{ V}$ | | 2.5 | 3.5 | pF |
| $\Delta C_{i/o-GND}$ | | | | 0.015 | | |
| $C_{i/o-i/o}$ | Capacitance between I/O | $V_R = 1.65\text{ V}$ | | 1.2 | 1.7 | pF |
| $\Delta C_{i/o-i/o}$ | | | | 0.04 | | |

Figure 2. Capacitance versus voltage (typical values)

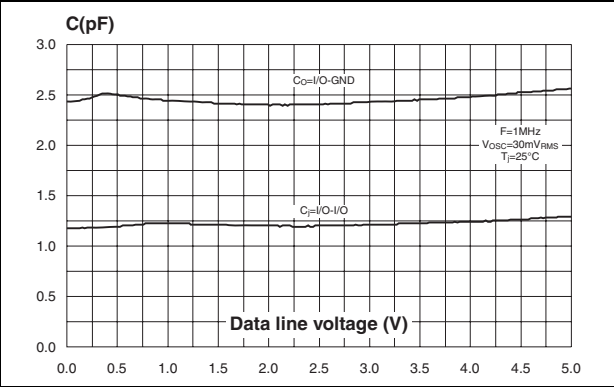


Figure 3. Line capacitance versus frequency (typical values)

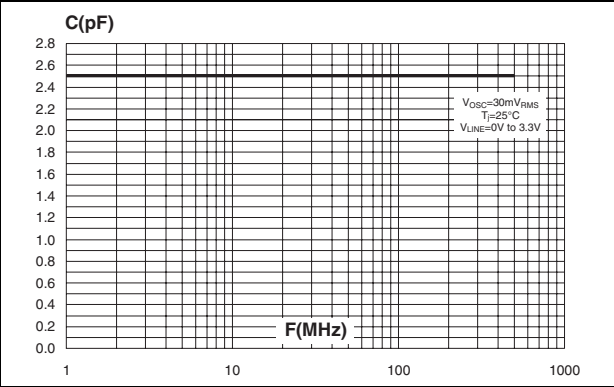


Figure 4. Leakage current versus junction temperature (typical values, $V_R = 1\text{ V}$)

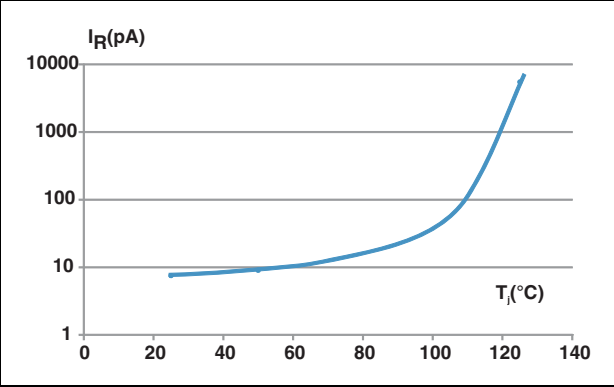


Figure 5. Leakage current versus reverse applied voltage (typical values)

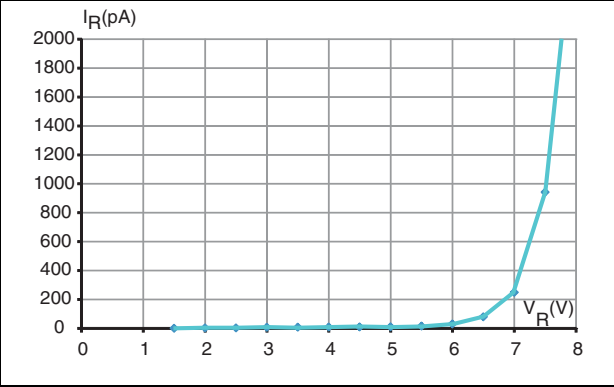


Figure 6. ESD response to IEC 61000-4-2 (+8 kV contact discharge)

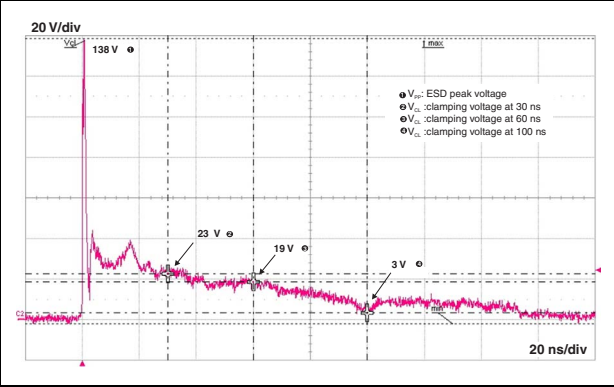


Figure 7. ESD response to IEC 6100-4-2 (-8 kV contact discharge)

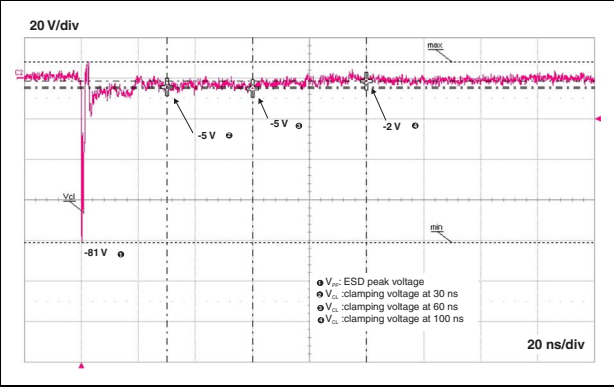


Figure 8. S21 attenuation measurement result

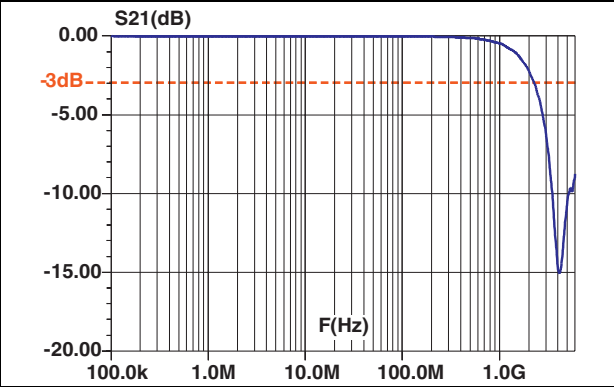
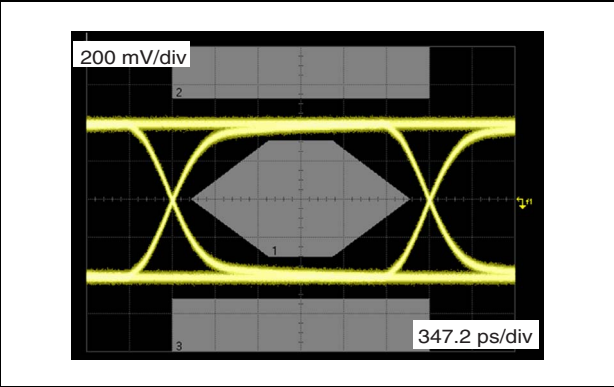
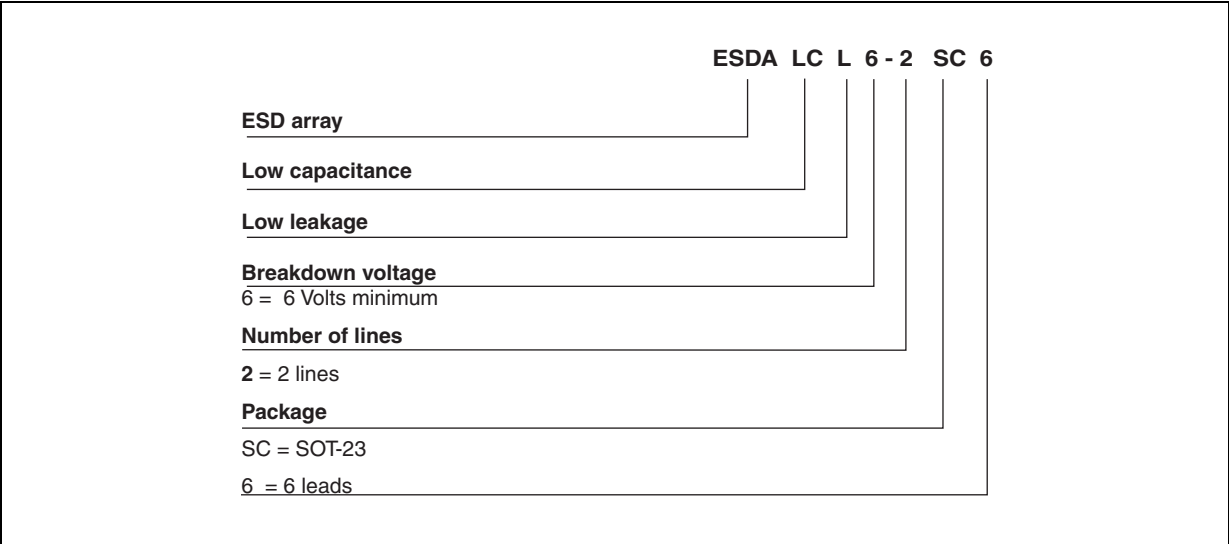


Figure 9. USB2.0 eye diagram



2 Ordering information scheme

Figure 10. Ordering information scheme



3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

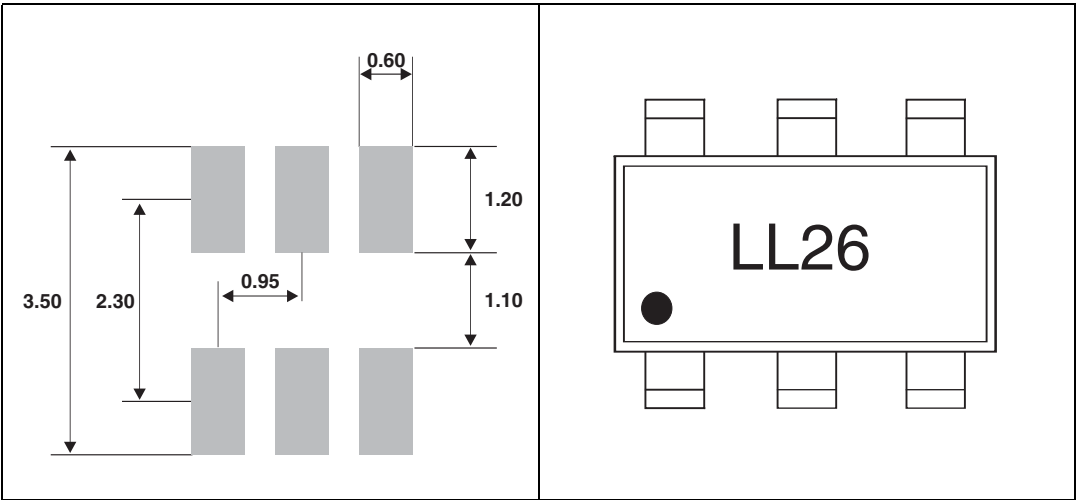
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Table 3. SOT23-6L dimensions

| Ref. | Dimensions | | | | | |
|------|-------------|------|------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 0.90 | | 1.45 | 0.035 | | 0.057 |
| A1 | 0 | | 0.15 | 0 | | 0.006 |
| A2 | 0.90 | | 1.30 | 0.035 | | 0.051 |
| b | 0.30 | | 0.50 | 0.012 | | 0.020 |
| c | 0.09 | | 0.20 | 0.004 | | 0.008 |
| D | 2.80 | | 3.05 | 0.11 | | 0.118 |
| E | 1.50 | | 1.75 | 0.059 | | 0.069 |
| e | | 0.95 | | | 0.037 | |
| H | 2.60 | | 3.00 | 0.102 | | 0.118 |
| L | 0.30 | | 0.60 | 0.012 | | 0.024 |
| θ | 0° | | 10° | 0° | | 10° |

Figure 11. SOT23-6L footprint dimensions in mm

Figure 12. SOT23-6L marking



4 Ordering information

Table 4. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|---------------|---------|----------|---------|----------|---------------|
| ESDALCL6-2SC6 | LL26 | SOT23-6L | 16.7 mg | 3000 | Tape and reel |

5 Revision history

Table 5. Document revision history

| Date | Revision | Changes |
|-------------|----------|--------------|
| 31-Oct-2012 | 1 | First issue. |

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